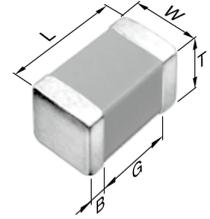


C3216C0G2J332K160AA



**TDK item description** C3216C0G2J332KT\*\*\*\*

<b>Applications</b>	Commercial Grade
<b>Feature</b>	Mid Voltage (100 to 630V)
<b>Series</b>	C3216 [EIA 1206]
<b>Status</b>	Production (Not Recommended for New Design)



Dimensions in mm

Size	
Length(L)	3.20mm ±0.20mm
Width(W)	1.60mm ±0.20mm
Thickness(T)	1.60mm ±0.20mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	1.00mm Min.
Recommended Land Pattern (PA)	2.10mm to 2.50mm(Flow Soldering)
	2.00mm to 2.40mm(Reflow Soldering)
Recommended Land Pattern (PB)	1.10mm to 1.30mm(Flow Soldering)
	1.00mm to 1.20mm(Reflow Soldering)
Recommended Land Pattern (PC)	1.00mm to 1.30mm(Flow Soldering)
	1.10mm to 1.60mm(Reflow Soldering)

Electrical Characteristics	
Capacitance	3.3nF ±10%
Rated Voltage	630VDC
Temperature Characteristic	C0G(0±30ppm/°C)
Q (Min.)	1000
Insulation Resistance (Min.)	10000MΩ

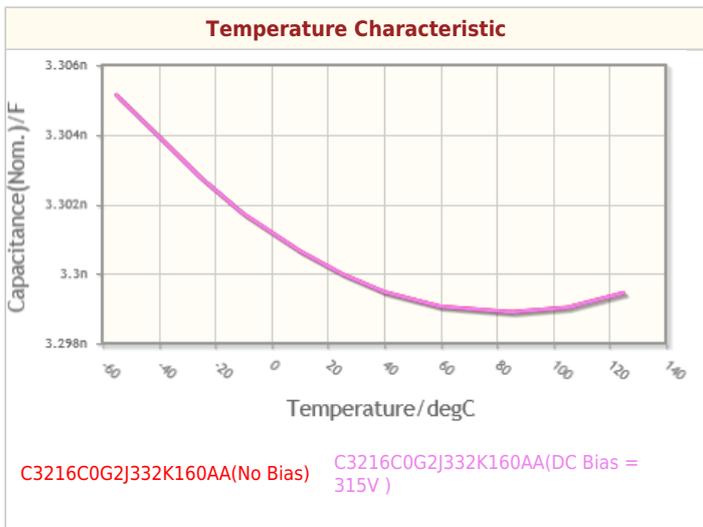
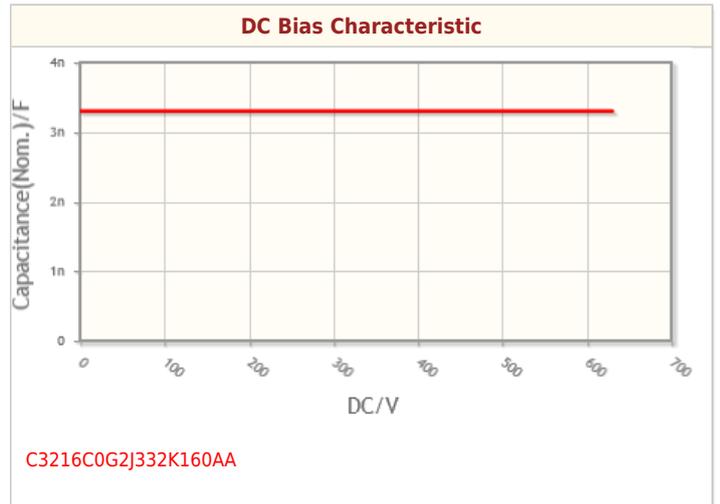
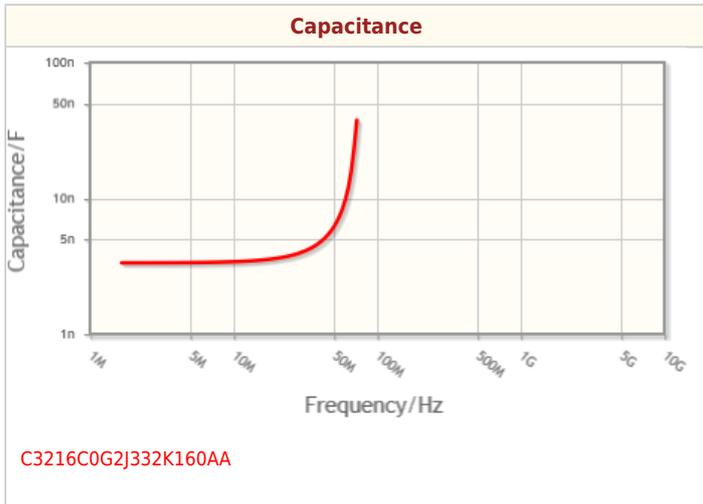
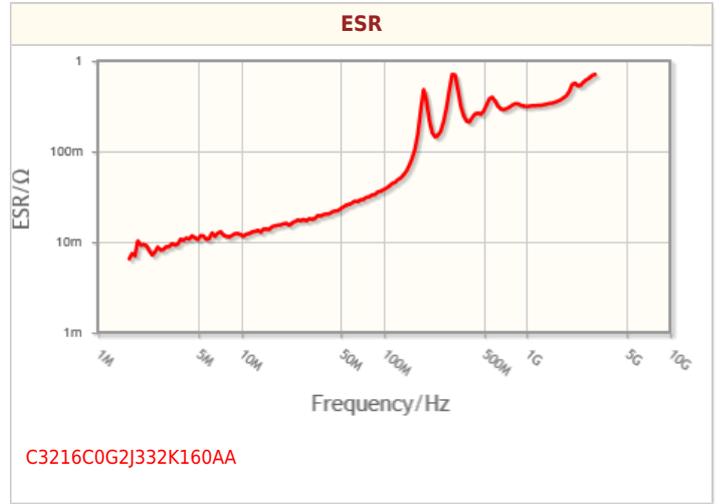
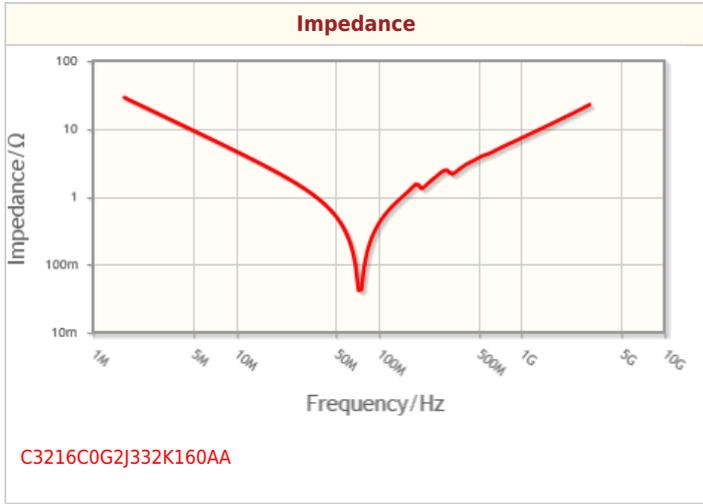
Other	
Soldering Method	Wave (Flow)
	Reflow
AEC-Q200	No
Packing	Blister (Plastic)Taping [180mm Reel]
Package Quantity	2000pcs

! Images are for reference only and show exemplary products.  
! This PDF document was created based on the data listed on the TDK Corporation website.  
! All specifications are subject to change without notice.

C3216C0G2J332K160AA



Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)



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## Associated Images

